IPC ASSOCIATION CONI		Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
upplier Inf	formation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi											2024-04-25			
Contact Name	:	Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-S	Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized Re	epresentative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
Product-Env-S	Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
Rec	quester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	M	Manufacturing Site		eight*	UOM	Unit Type
		AFGB30	AFGB30T65SQDN 650V/30A FS4 IGB AUTOMOTIVE		BT TO263		2024-04-25		С	PA	1	178.468	mg	Each
Ianufactur	ring Proccess Informa	ation												
Terr	Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MSL			Peak Process Body Temperature Max Time at Peak				Temperatu	re Numb	er of Reflow Cyc	cles
Matte Tin (Sn) - annealed		•	CU Alloy				260		C	30	second	s 3		
omments														
vel 1 - maxim	num time at peak temperat	ture during sol	ldering is 10-3	30 seconds										
or more infor	rmation regarding materia	l composition	please refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.5	mg	Supplier	Silicon (Si)	7440-21-3		4.5	mg
Die Attach Solder	0.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0175	mg
			A	Lead (Pb)	7439-92-1	7a	0.6475	mg
			Supplier	Tin (Sn)	7440-31-5		0.035	mg
Lead Frame	860.318		Supplier	Tin (Sn)	7440-31-5		1.0324	mg
			В	Nickel (Ni)	7440-02-0		0.4302	mg
			Supplier	Copper (Cu)	7440-50-8		858.8555	mg
Mold Compound-Black	602.8		Supplier	Brominated Epoxy Resin-2	68541-56-0		15.07	mg
			Supplier	Other Epoxy resins	Proprietary Data		18.084	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		12.056	mg
			Supplier	Carbon Black (C)	1333-86-4		3.014	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		524.436	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		30.14	mg
Plating	5.52	mg	Supplier	Tin (Sn)	7440-31-5		5.52	mg
Wire Bond - Al	4.63	mg	Supplier	Aluminum (Al)	7429-90-5		4.63	mg